



Doc. Number :
☐ Tentative Specification
■ Preliminary Specification
☐ Approval Specification

MODEL NO.: M238HCJ SUFFIX: L30

Customer: Common					
APPROVED BY	SIGNATURE				
Name / Title Note Product Version B1					
Please return 1 copy for your signature and comments.	our confirmation with your				

Approved By	Checked By	Prepared By
梁永祥	陳立錚	趙宗信

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REVISION HISTORY

Version	Date	Section	Description
0.0	2014.09.16	All	Tentative Specification was first issued.
1.0	2014.11.21	All	Preliminary Specification was issued.

1. GENERAL DESCRIPTION

1.1 OVERVIEW

M238HCJ-L30 is a 23.8" TFT Liquid Crystal Display module with WLED Backlight unit and 30 pins 2ch-LVDS interface. This module supports 1920 x 1080 Full HD mode and can display up to 16.7M colors. The converter module for Backlight is not built in.

1.2 GENERAL SPECIFICATIONS

Item	Specification	Unit	Note
Screen Size	23.8" real diagonal		
Driver Element	a-si TFT active matrix	-	-
Pixel Number	1920 x R.G.B. x 1080	pixel	-
Pixel Pitch	0.0915 (H) x 0.2745 (V)	mm	-
Pixel Arrangement	RGB vertical stripe	-	ı
Display Colors	16.7M	color	-
Transmissive Mode	Normally black	-	-
Surface Treatment	AG type, 3H hard coating, Haze 25	-	ı
Luminance, White	250	Cd/m2	
Color Gamut	72% of NTSC(Typ.)	-	
ROHS, Halogen Free &TCO 5.2	ROHS, Halogen Free TCO 5.2 compliance	-	
Power Consumption	Total (TBD)W(Max.)@cell (7W) (Max.), BL (13.1)	W (Max.)	(1)

Note (1) The specified power consumption: Total= cell (reference 4.3.1)+BL (reference 4.3.3)

2. MECHANICAL SPECIFICATIONS

Item		Min.	Тур.	Max.	Unit	Note
	Horizontal (H)	542.5	543	543.5	mm	
Module Size	Vertical (V)	316.9	317.4	317.9	mm	(1)
	Thickness (T)	10.8	11.3	11.8	mm	
Bezel Area	Horizontal	529.7	530.2	530.7	mm	
Dezei Alea	Vertical	299.1	299.6	300.1	mm	
Active Area	Horizontal	526.54	527.04	527.54	mm	
Active Area	Vertical	295.96	296.46	296.96	mm	
Weight			(2300)		g	

Note (1) Please refer to the attached drawings for more information of front and back outline dimensions.

3. ABSOLUTE MAXIMUM RATINGS

3.1 ABSOLUTE RATINGS OF ENVIRONMENT

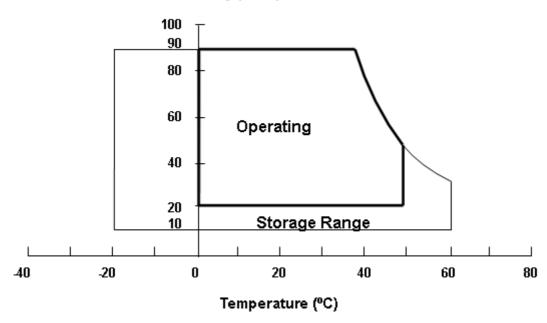
Item	Symbol	Va	lue	Unit	Note	
item	Symbol	Min.	Max.	Offic	Note	
Storage Temperature	TST	-20	60	ºC	(1)	
Operating Ambient Temperature	TOP	0	50	ºC	(1), (2)	

Note (1)

- (a) 90 %RH Max.
- (b) Wet-bulb temperature should be 39 °C Max.
- (c) No condensation.

Note (2) Panel surface temperature should be 0° C min. and 65° C max under Vcc=12.0V, Input fr =60Hz, typical LED string current, 25° C ambient temperature, and no humidity control. Any condition of ambient operating temperature, the surface of active area should be keeping not higher than 65° C





3.2 ELECTRICAL ABSOLUTE RATINGS

3.2.1 TFT LCD MODULE

Item	Symbol	Symbol		Unit	Note
		Min.	Max.		
Power Supply Voltage	VCCS	-0.3	6.0	V	(1)
Logic Input Voltage	V_{IN}	-0.3	3.6	V	(1)

3.2.2 BACKLIGHT UNIT

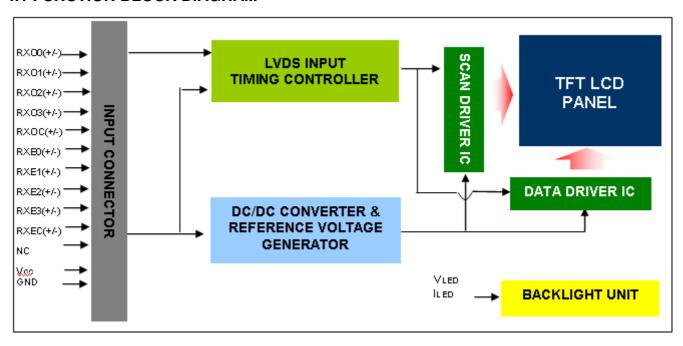
ltem	Symbol		Value		Unit	Note	
Item	Symbol	Min.	Тур	Max.	Offic	Note	
LED Forward Current Per Input Pin	I _F	0	55	(60)	mA	(1), (2) Duty=100%	
LED Pulse Forward Current Per Input Pin	l _P			(500)	mA	(1), (2) Pulse Width≦10msec. and Duty≦25%	

Note (1) Permanent damage to the device may occur if maximum values are exceeded. Function operation should be restricted to the conditions described under Normal Operating Conditions.

Note (2) Specified values are for input pin of LED light bar at Ta=25±2 °C (Refer to 4.3.3 and 4.3.4 for further information).

4. ELECTRICAL SPECIFICATIONS

4.1 FUNCTION BLOCK DIAGRAM



4.2. INTERFACE CONNECTIONS

PIN ASSIGNMENT

Pin	Name	Description
1	RXO0-	Negative LVDS differential data input. Channel O0 (odd)
2	RXO0+	Positive LVDS differential data input. Channel O0 (odd)
3	RXO1-	Negative LVDS differential data input. Channel O1 (odd)
4	RXO1+	Positive LVDS differential data input. Channel O1 (odd)
5	RXO2-	Negative LVDS differential data input. Channel O2 (odd)
6	RXO2+	Positive LVDS differential data input. Channel O2 (odd)
7	GND	Ground
8	RXOC-	Negative LVDS differential clock input. (odd)
9	RXOC+	Positive LVDS differential clock input. (odd)
10	RXO3-	Negative LVDS differential data input. Channel O3(odd)
11	RXO3+	Positive LVDS differential data input. Channel O3 (odd)
12	RXE0-	Negative LVDS differential data input. Channel E0 (even)
13	RXE0+	Positive LVDS differential data input. Channel E0 (even)
14	GND	Ground
15	RXE1-	Negative LVDS differential data input. Channel E1 (even)
16	RXE1+	Positive LVDS differential data input. Channel E1 (even)
17	GND	Ground
18	RXE2-	Negative LVDS differential data input. Channel E2 (even)
19	RXE2+	Positive LVDS differential data input. Channel E2 (even)
20	RXEC-	Negative LVDS differential clock input. (even)
21	RXEC+	Positive LVDS differential clock input. (even)
22	RXE3-	Negative LVDS differential data input. Channel E3 (even)
23	RXE3+	Positive LVDS differential data input. Channel E3 (even)
24	GND	Ground
25	NC	For LCD internal use only, Do not connect
Pin	Name	Description
26	NC	For LCD internal use only, Do not connect
27	NC	For LCD internal use only, Do not connect
28	Vcc	+5.0V power supply
29	Vcc	+5.0V power supply
30	Vcc	+5.0V power supply

Note (1) Connector Part No.:

Foxconn; GS23301-0321R-7H

or FCN: WF13-422-3033 or P-TWO: 187098-30091 or equivalent.

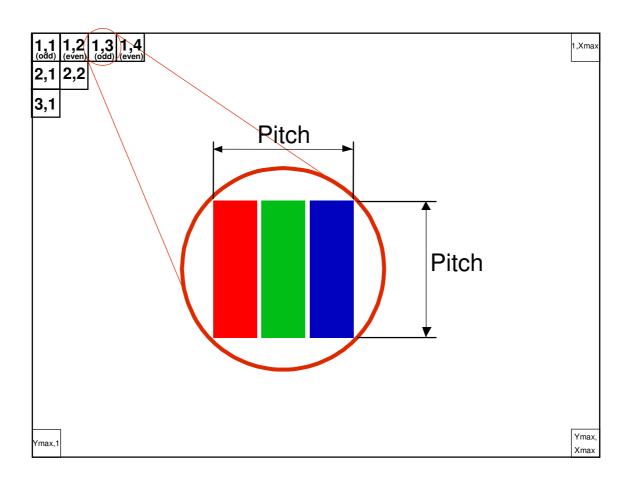
Note (2) User's connector Part No:

Mating Wire Cable Connector Part No.: FI-X30H(JAE) or FI-X30HL(JAE)

Mating FFC Cable Connector Part No.: 217007-013001 (P-TWO) or JF05X030-1 (JAE).

Note (3) The first pixel is odd.

Note (4) Input signal of even and odd clock should be the same timing.



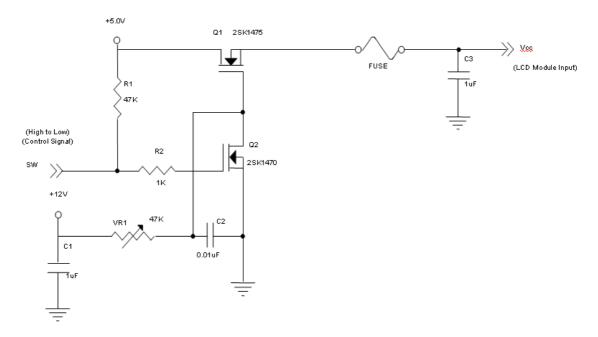
4.3 ELECTRICAL CHARACTERISTICS

4.3.1 LCD ELETRONICS SPECIFICATION

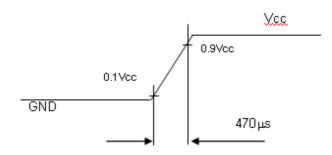
Paramo	Parameter			Value		Unit	Note
Farameter		Symbol	Min.	Тур.	Max.	Offic	NOLE
Power Supply	/ Voltage	Vcc	4.5	5.0	5.5	V	-
Ripple Vo	Itage	V_{RP}	-	-	300	mV	-
Rush Cui	rrent	I _{RUSH}	-	-	3	Α	(2)
	White		-	(0.83)	(0.95)	Α	(3)a
Power Supply Current	Black		-	(0.46)	(0.54)	Α	(3)b
	Vertical Stripe		-	(1.1)	(1.21)	Α	(3)c
Power Cons	umption	PLCD	•	5.4	6.1	W	(4)
LVDS differential input voltage		Vid	100	-	600	mV	
LVDS common input voltage		Vic	1.0	1.2	1.4	V	
LVDS Logic High	VIH		-	0.1	V		
LVDS Logic Low	Input Voltage	VIL	-0.1	-		V	

Note (1) The ambient temperature is $Ta = 25 \pm 2$ °C.

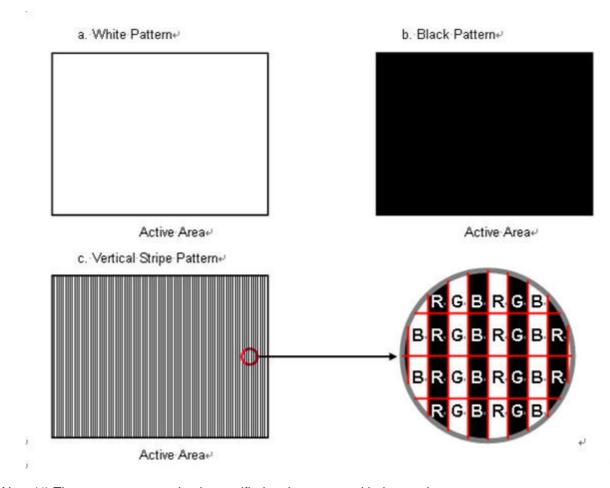
Note (2) Measurement Conditions:



Vcc rising time is 470µs

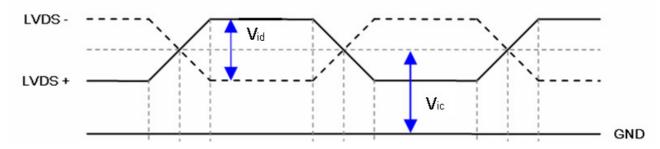


Note (3) The specified max power supply current is under the conditions at Vcc = 5.0 V, $Ta = 25 \pm 2 \,^{\circ}\text{C}$, Fr = 60Hz, whereas a power dissipation check pattern below is displayed.

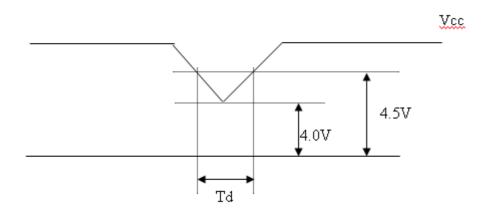


Note (4) The power consumption is specified at the pattern with the maximum current.

Note (5) VID waveform condition



4.3.2 VCC POWER DIP CONDITION



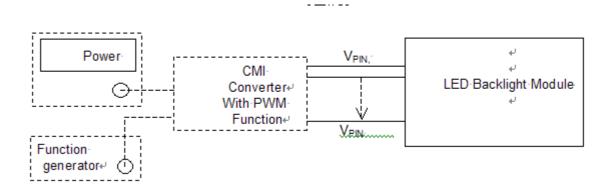
Dip condition:4.0 ≤ Vcc ≤ 4.5, Td ≤ 20ms

4.3.3 BACKLIGHT UNIT

Parameter	Symbol		Value		Unit	Note
Farameter	Syllibol	Min.	Тур.	Max.	Offic	Note
LED Light Bar Input Voltage Per Input Pin	VPIN		54.4	59.5	V	(1), Duty=100%, IPIN=70mA
LED Light Bar Current Per Input Pin	IPIN		55		mA	(1), (2) Duty=100%
LED Life Time	LLED	40000			Hrs	(3)
Power Consumption	PBL		11.97	13.1	W	(1) Duty=100%, IPIN=70mA

Note (1) LED light bar input voltage and current are measured by utilizing a true RMS multimeter as shown below:

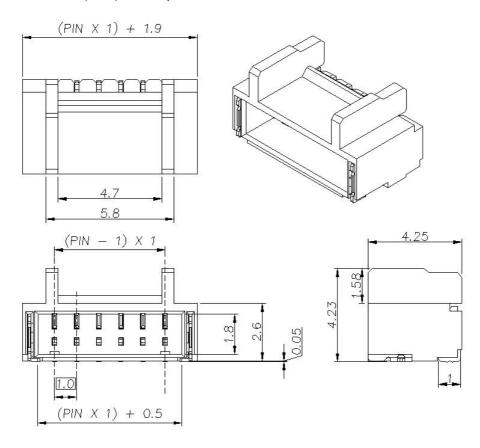
Note (2) PBL(Typ) = IPIN(Typ) \times VPIN(Typ) \times (4) PBL(Max) = IPIN(TYP) \times VPIN(Max) \times (4) input pins.. Note (3) The lifetime of LED is defined as the time when LED packages continue to operate under the conditions at Ta = 25 \pm 2 $^{\circ}$ C and I= (55)mA (per chip) until the brightness becomes \leq 50% of its original value.



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4.3.4 LIGHTBAR Connector Pin Assignment

Connector: WM13-406-063N (FCN) or Compatible

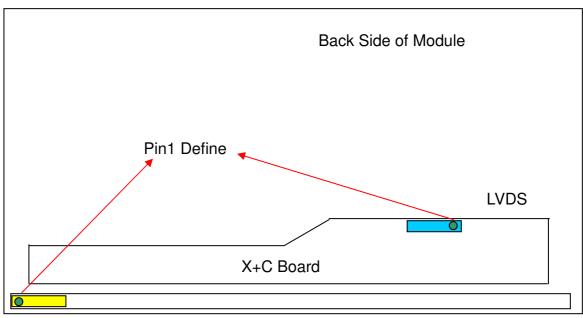


CN1

Pin number	Description
1	Cathode of LED string
2	Cathode of LED string
3	VLED
4	VLED
5	Cathode of LED string
6	Cathode of LED string

Note(1) Connector(wire type):FCN(WM13-406-063N) or equivalent.

Note(2) User's mating connector part No.: FCN(WF1300106-B) and hook width must be less than 4.5mm.



Light Bar

4.4 LVDS INPUT SIGNAL SPECIFICATIONS

4.4.1 LVDS DATA MAPPING TABLE

LVDS Channel O0	LVDS output	D7	D6	D4	D3	D2	D1	D0
LVD3 Onamile 00	Data order	OG0	OR5	OR4	OR3	OR2	OR1	OR0
LVDS Channel O1	LVDS output	D18	D15	D14	D13	D12	D9	D8
LVD3 GHarifiel O1	Data order	OB1	OB0	OG5	OG4	OG3	OG2	OG1
LVDS Channel O2	LVDS output	D26	D25	D24	D22	D21	D20	D19
LVD3 Ghanner O2	Data order	DE	NA	NA	OB5	OB4	OB3	OB2
LVDS Channel O3	LVDS output	D23	D17	D16	D11	D10	D5	D27
LVD3 Channel O3	Data order	NA	OB7	OB6	OG7	OG6	OR7	OR6
LVDS Channel E0	LVDS output	D7	D6	D4	D3	D2	D1	D0
LVD3 GHAHHELEU	Data order	EG0	ER5	ER4	ER3	ER2	ER1	ER0
LVDS Channel E1	LVDS output	D18	D15	D14	D13	D12	D9	D8
LVD3 GHanner E1	Data order	EB1	EB0	EG5	EG4	EG3	EG2	EG1
LVDS Channel E2	LVDS output	D26	D25	D24	D22	D21	D20	D19
LVD3 GHanner E2	Data order	DE	NA	NA	EB5	EB4	EB3	EB2
LVDS Channel E3	LVDS output	D23	D17	D16	D11	D10	D5	D27
LVD3 GHaffilet E3	Data order	NA	EB7	EB6	EG7	EG6	ER7	ER6

4.4.2 COLOR DATA INPUT ASSIGNMENT

The brightness of each primary color (red, green and blue) is based on the 8-bit gray scale data input for the color. The higher the binary input, the brighter the color. The table below provides the assignment of color versus data input.

												Da		Sigr											
	Color				Re	ed							G	reer	1						Βlι	Je			
	Goloi	R7	R6	R5	R4	R3	R2	R1	R0	G 7	G 6	G 5	G 4	G3	G2	G1	G0	B 7	B6	B5	B4	ВЗ	B2	B 1	B 0
	Black Red	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	Ö	0	0	0	0	0	0	0
Basic	Blue	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
Colors	Cyan	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
00.0.0	Magenta	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Red(0) / Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(1)	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Gray	Red(2)	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Scale	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Of	:	:	:	:	:	:		:		:		:	_	:	:	:			:		:	:	:	:	
Red	Red(253)	1	1	1	1	1	1	0	1	0	0	0	:0	0	0	0	0	0	0	0	0	0	0	0	:0
	Red(254)	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(255)	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green(0) / Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green(1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0
Gray	Green(2)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0
Scale	:							-					•						:			•			1 : 1
Of	Green(253)	0	:			: 0	:	:		1	1	1	1	1	: 1		: 1	:	: 0	: 0	:	: 0	: 0	-	انا
Green	Green(254)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0
	Green(255)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	Blue(0) / Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue(1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
	Blue(2)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Õ	0	0	0	0	0	0	0	1	0
Gray	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:		ı : I
Scale	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	l :	:	:	:	:	:	ı :
Of	Blue(253)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	0	1
Blue	Blue(254)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0
	Blue(255)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1

Note (1) 0: Low Level Voltage, 1: High Level Voltage

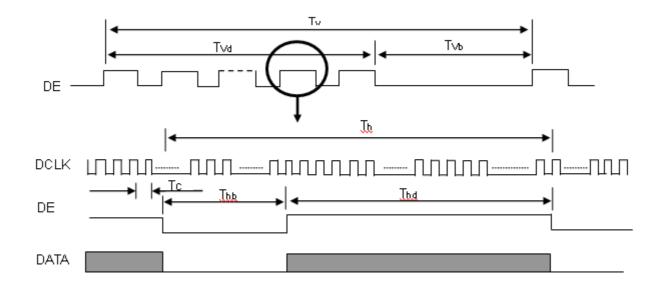
4.5 DISPLAY TIMING SPECIFICATIONS

The input signal timing specifications are shown as the following table and timing diagram.

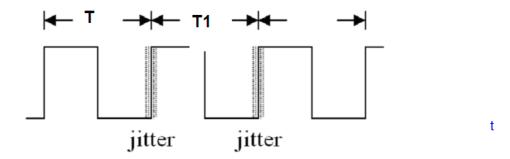
Signal	Item	Symbol	Min.	Тур.	Max.	Unit	Note
	Frequency	Fc	58.54	74.25	(97.98)	MHz	-
	Period	Tc	•	13.47	-	ns	
	Input cycle to cycle jitter	T _{rcl}	-0.02*Tc	-	0.02*Tc	ns	(1)
	Input Clock to data skew	TLVCCS	-0.02*Tc	-	0.02*Tc	ps	(2)
LVDS Clock	Spread spectrum modulation range	F _{clkin_mod}	0.97*Fc	-	1.03*Fc	MHz	(2)
	Spread spectrum modulation frequency	F _{SSM}	1	-	100 KHz		(3)
	Frame Rate	Fr	50	60	(75)	Hz	Tv=Tvd+Tvb
	Total	Tv	1115	1125	1136	Th	-
Vertical Display Term	Active Display	Tvd	1080	1080	1080	Th	-
	Blank	Tvb	35	45	56	Th	-
	Total	Th	1050	1100	1150	Tc	Th=Thd+Thb
Horizontal Display Term	Active Display	Thd	960	960	960	Тс	-
	Blank	Thb	90	140	190	Tc	-

Note: Because this module is operated by DE only mode, Hsync and Vsync input signals are ignored.

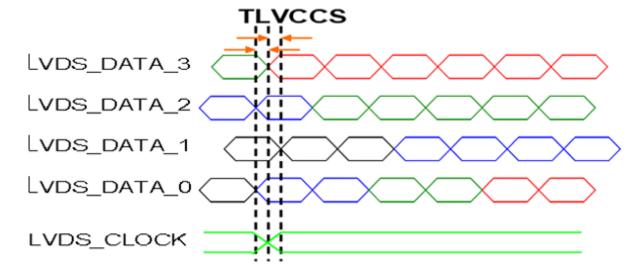
INPUT SIGNAL TIMING DIAGRAM



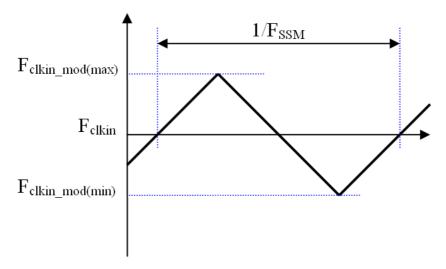
Note (1) The input clock cycle-to-cycle jitter is defined as below figures. Trcl = $IT_1 - TI$



Note (2) Input Clock to data skew is defined as below figures.



Note (3) The SSCG (Spread spectrum clock generator) is defined as below figures.

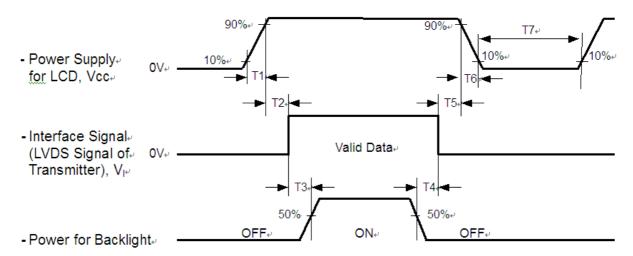


Note(4) The DCLK range at last line of V-blank should be set in 0 to Hdisplay/2

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4.6 POWER ON/OFF SEQUENCE

The power sequence specifications are shown as the following table and diagram.



Timing Specifications:

Parameters		Values		Units
i arameters	Min	Тур.	Max	Office
T1	0.5	•	10	ms
T2	0	30	50	ms
T3	450	-	-	ms
T4	100	250	-	ms
T5	0	20	50	ms
T6	0.1	-	100	ms
T7	1000	-	-	ms

- Note (1) The supply voltage of the external system for the module input should be the same as the definition of Vcc.
- Note (2) When the backlight turns on before the LCD operation of the LCD turns off, the display may momentarily become abnormal screen.
- Note (3) In case of VCC = off level, please keep the level of input signals on the low or keep a high impedance.
- Note (4) T7 should be measured after the module has been fully discharged between power off and on period.
- Note (5) Interface signal shall not be kept at high impedance when the power is on.
- Note (6) CMI won't take any responsibility for the products which are damaged by the customers not following the Power Sequence.
- Note (7) There might be slight electronic noise when LCD is turned off (even backlight unit is also off). To avoid this symptom, we suggest "Vcc falling timing" to follow "t6 spec".

5. OPTICAL CHARACTERISTICS

5.1 TEST CONDITIONS

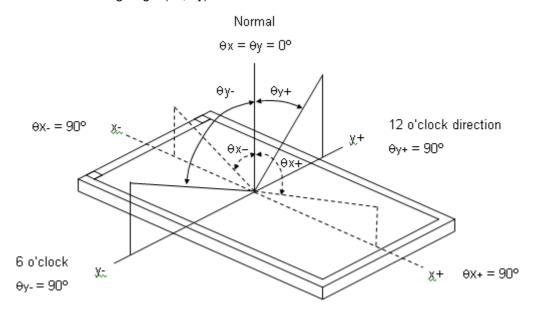
Item	Symbol	Value	Unit
Ambient Temperature	Ta	25±2	O°
Ambient Humidity	На	50±10	%RH
Supply Voltage	V_{CC}	5	V
Input Signal	According to typical va	alue in "3. ELECTRICAL (CHARACTERISTICS"
LED Light Bar Input Current Per Input Pin	I _{PIN}	(85± 2.55)	mA _{DC}
PWM Duty Ratio	D	100	%
LED Light Bar Test Converter		CMI 35-D080484	

5.2 OPTICAL SPECIFICATIONS

The relative measurement methods of optical characteristics are shown in 5.2. The following items should be measured under the test conditions described in 5.1 and stable environment shown in Note (5).

Iter	n	Symbol	Condition	Min.	Тур.	Max.	Unit	Note
	Red	Rx			0.644			
	neu	Ry			0.343			
Oala	Green	Gx			0.327			
Color	arcon	Gy		Тур –	0.608	Тур +		(1) (5)
Chromaticity (CIE 1931)	Blue	Bx	$\theta_x = 0^\circ$, $\theta_Y = 0^\circ$	0.03	0.150	0.03	_	(1), (5)
(312 1331)	Blue	Ву	CS-2000 R=G=B=255		0.045			
	White	Wx	Gray scale		0.313			
	vviille	Wy			0.329			
Center Lumina (Center of		L _C		200	250	-	cd/m ²	(4), (5)
Contrast	Ratio	CR		700	1000	-	-	(2), (5)
		TR		-	(14)	(19)		
Respons	e Time	T _F	$\theta_x=0^\circ$, $\theta_Y=0^\circ$		11	16	ms	(3)
		T _{GtG_AVE}		-	(18)	(23)		
White Va	riation	δW	$\theta_x=0^\circ$, $\theta_Y=0^\circ$	75			%	(5), (6)
Viewing Angle	Horizontal	$\theta x - + \theta x +$	CR ≧ 10	170	178	-	Dog	(1) (5)
viewing Angle	Vertical	θy- + θy+	ON ≦ 10	170	178	-	Deg.	(1), (5)

Note (1) Definition of Viewing Angle (θx , θy):



Note (2) Definition of Contrast Ratio (CR):

The contrast ratio can be calculated by the following expression.

Contrast Ratio (CR) = L255 / L0

L255: Luminance of gray level 255

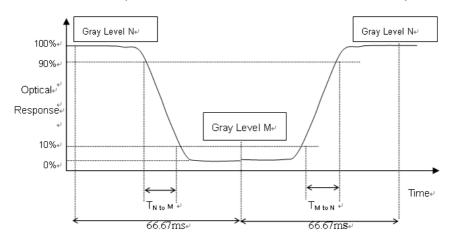
L 0: Luminance of gray level 0

CR = CR(5)

CR (X) is corresponding to the Contrast Ratio of the point X at Figure in Note (6).

Note (3) Definition of Response Time:

- -The T_R is the rising-time means the transition time from "Full-Black (gray 0)" to "Full-White (gray 255)" and the T_F is the falling-time means the transition time from "Full-White (gray 255)" to "Full-White (gray 0)" as the following figure. (Measured by TEKTRONIX TDS3054B).
- -The T_{GtG} is the response time means the transition time from "Gray N" to "Gray M" (N,M=0~255).



- $T_{\text{GtG_AVE}}$ is the total average of the T_{GtG} data (Measured by INX GTG instrument)
- The gray (N,M) stands for the (0,31,63,~255) as the following table.
- If system uses ODC (Over Driving Circuit) function to improve the transition of LC , T_{GtG_AVE} may be **12ms~18ms**.
- * It depends on Overshoot rate.

Gray to	Crav					Rising tim	е			
Gray to	Glay	0	31	63	95	127	159	191	223	255
	0									
1 [31									
] [63									
1 [95									
Falling time	127									
1 [159									
1 [191									
[223									
	255									

Note (4) Definition of Luminance of White (L_C):

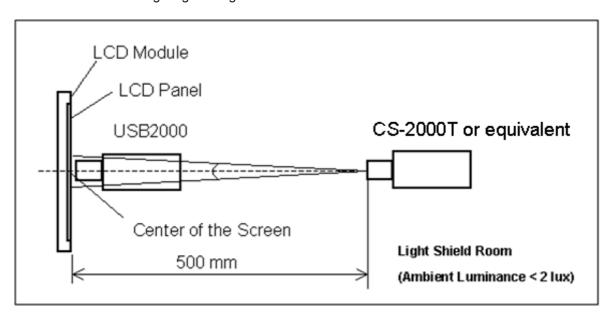
Measure the luminance of gray level 255 at center point

$$L_{\rm C} = L (5)$$

L (x) is corresponding to the luminance of the point X at Figure in Note (6).

Note (5) Measurement Setup:

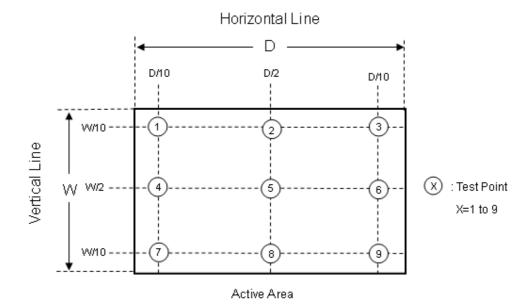
The LCD module should be stabilized at given temperature for 40 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 40 minutes in a windless room.



Note (6) Definition of White Variation (δW):

Measure the luminance of gray level 255 at 9 points

$$\delta W = Minimum [L (1) \sim L (9)] / Maximum [L (1) \sim L (9)]$$



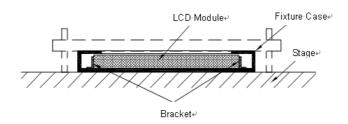
6. RELIABILITY TEST ITEM

Items	Required Condition	Note
Temperature Humidity Bias (THB)	Ta= 50℃ , 80%RH, 240hours	
High Temperature Operation (HTO)	Ta= 50°C , 240hours	
Low Temperature Operation (LTO)	Ta= 0°C , 240hours	
High Temperature Storage (HTS)	Ta= 60°C , 240hours	
Low Temperature Storage (LTS)	Ta= -20°C , 240hours	
Vibration Test (Non-operation)	Acceleration: 1.5 G Wave: Sine Frequency: 10 - 300 Hz Sweep: 30 Minutes each Axis (X, Y, Z)	
Shock Test (Non-operation)	Acceleration: 50 G Wave: Half-sine Active Time: 11 ms Direction: ± X, ± Y, ± Z.(one time for each Axis)	
Thermal Shock Test (TST)	-20 $^{\circ}$ C/30min , 60 $^{\circ}$ C / 30min , 100 cycles	
On/Off Test	25° C ,On/10sec , Off /10sec , 30,000 cycles	
ESD (Electro Static Discharge)	Contact Discharge: ± 8KV, 150pF(330Ω) Air Discharge: ± 15KV, 150pF(330Ω)	
Altitude Test	Operation:10,000 ft / 24hours Non-Operation:30,000 ft / 24hours	

- Note (1) criteria: Normal display image with no obvious non-uniformity and no line defect.
- Note (2) Evaluation should be tested after storage at room temperature for more than two hour
- Note (3) At testing Vibration and Shock, the fixture in holding the module has to be hard and rigid enough so that the module would not be twisted or bent by the fixture.

The fixing condition is shown as below:

At Room Temperature



7. PACKING

7.1 PACKING SPECIFICATIONS

(1) 10 LCD modules / 1 Box

(2) Box dimensions: 620(L) X 348(W) X 430(H) mm

(3) Weight: approximately: 28 kg (10 modules per box)

7.2 PACKING METHOD

(1) Carton Packing should have no failure in the following reliability test items.

Test Item	Test Conditions	Note
	ISTA STANDARD	
	Random, Frequency Range: 1 – 200 Hz	
Vibration	Top & Bottom: 30 minutes (+Z), 10 min (-Z),	Non Operation
	Right & Left: 10 minutes (X)	·
	Back & Forth 10 minutes (Y)	
Dropping Test	1 Corner , 3 Edge, 6 Face, 31cm	Non Operation

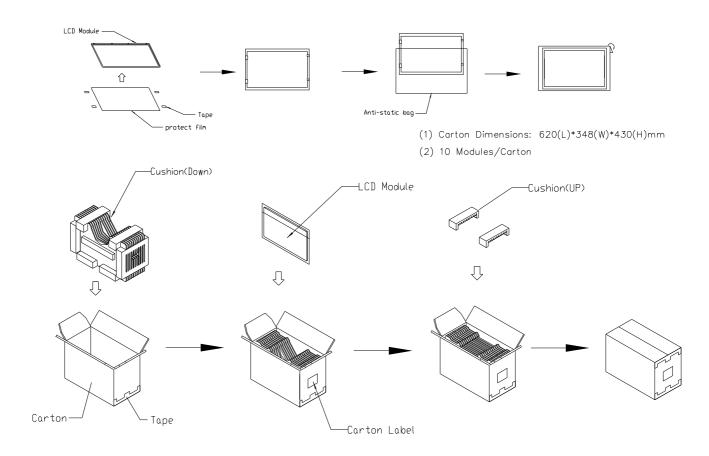


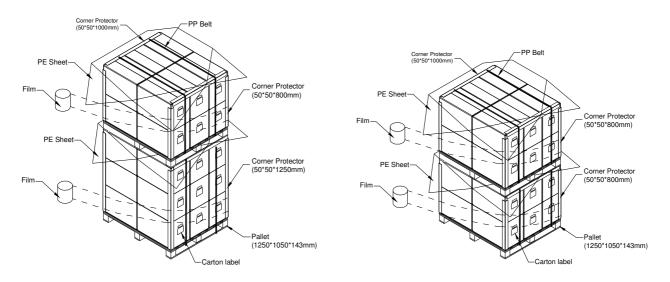
Figure. 7-1 Packing method

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7.3 PALLET

For ocean shipping

Sea / Land Transportation (40ft HQ Container) Sea / Land Transportation (40ft Container)



For air transport

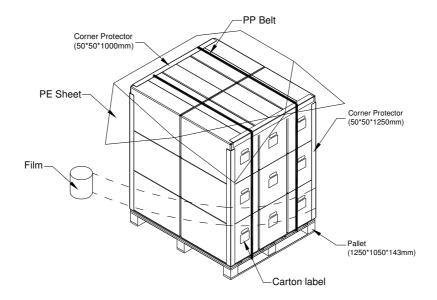
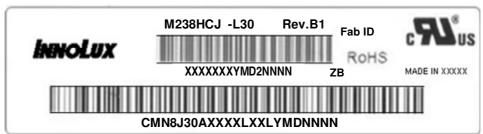


Figure. 7-2 Packing method

8. Innolux MODULE LABEL

The barcode nameplate is pasted on each module as illustration, and its definitions are as following explanation.



(a) Model Name: M238HCJ-L30

(b) Revision: Rev. XX, for example: A0, A1... B1, B2... or C1, C2...etc.

(c) Innolux barcode definition:

Serial ID: XX-XX-X-XX-YMD-L-NNNN

Code	Meaning	Description
XX	Innolux internal use	-
XX	Revision	Cover all the change
Х	Innolux internal use	-
XX	Innolux internal use	-
YMD	Year, month, day	Year: 0~9, 2001=1, 2002=2, 2003=32010=0, 2011=1, 2012=2 Month: 1~12=1, 2, 3, ~, 9, A, B, C Day: 1~31=1, 2, 3, ~, 9, A, B, C, ~, W, X, Y, exclude I, O, and U.
L	Product line #	Line 1=1, Line 2=2, Line 3=3,
NNNN	Serial number	Manufacturing sequence of product

(d) Customer's barcode definition:

Serial ID: CM- N8J30-X-X-X-XX-L-XX-L-YMD-NNNN

Code	Meaning	Description
CM	Supplier code	Innolux =CM
N8J30	Model number	M238HCJ-L30= N8J30
Х	Revision code	Non ZBD: 1,2,~,8,9 / ZBD: A~Z
Х	Source driver IC code	Century=1, CLL=2, Demos=3, Epson=4, Fujitsu=5, Himax=6, Hitachi=7, Hynix=8, LDI=9, Matsushita=A, NEC=B, Novatec=C,
Х	Gate driver IC code	OKI=D, Philips=E, Renasas=F, Samsung=G, Sanyo=H, Sharp=I, TI=J, Topro=K, Toshiba=L, Windbond=M, ILITEK=Q, Fiti=Y, None IC =Z
XX	Cell location	Tainan Taiwan=TN, Ningbo China=CN, Hsinchu Taiwan=SC
L	Cell line #	1,2,~,9,A,B,~,Y,Z
XX	Module location	Tainan, Taiwan=TN; Ningbo China=NP, Shenzhen China=SH
L	Module line #	1,2,~,9,A,B,~,Y,Z
YMD	Year, month, day	Year: 0~9, 2001=1, 2002=2, 2003=32010=0, 2011=1, 2012=2 Month: 1~12=1, 2, 3, ~, 9, A, B, C Day: 1~31=1, 2, 3, ~, 9, A, B, C, ~, T, U, V
NNNN	Serial number	By LCD supplier

(e) FAB ID(UL Factory ID):

Region	Factory ID
TWCMI	GEMN
NBCMI	LEOO
NBCME	CANO
NHCMI	CAPG

9. PRECAUTIONS

9.1 ASSEMBLY AND HANDLING PRECAUTIONS

- (1) Do not apply rough force such as bending or twisting to the module during assembly.
- (2) To assemble or install module into user's system can be only in clean working areas. The dust and oil may cause electrical short or worsen the polarizer.
- (3) It's not permitted to have pressure or impulse on the module because the LCD panel and Backlight will be damaged.
- (4) Always follow the correct power sequence when LCD module is connecting and operating. This can prevent damage to the CMOS LSI chips during latch-up.
- (5) Do not pull the I/F connector in or out while the module is operating.
- (6) Do not disassemble the module.
- (7) Use a soft dry cloth without chemicals for cleaning, because the surface of polarizer is very soft and easily scratched.
- (8) It is dangerous that moisture come into or contacted the LCD module, because moisture may damage LCD module when it is operating.
- (9) High temperature or humidity may reduce the performance of module. Please store LCD module within the specified storage conditions.
- (10)When ambient temperature is lower than 10°C may reduce the display quality. For example, the response time will become slowly.

9.2 STORAGE PRECAUTIONS

- (1) Do not leave the module in high temperature, and high humidity for a long time. It is highly recommended to store the module with temperature from 0° to 35° and relative humidity of less than 70%
- (2) Do not store the TFT LCD module in direct sunlight
- (3) The module should be stored in dark place. It is prohibited to apply sunlight or fluorescent light in storing

9.3 OPERATION PRECAUTIONS

(1) The LCD product should be operated under normal condition.

Normal condition is defined as below:

Temperature : 20±15°C Humidity: 65±20%

Display pattern: continually changing pattern(Not stationary)

(2) If the product will be used in extreme conditions such as high temperature, high humidity, high altitude, display pattern or operation time etc... It is strongly recommended to contact Innolux for application engineering advice. Otherwise, Its reliability and function may not be guaranteed.

9.4 SAFETY PRECAUTIONS

- (1) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contact with hands, skin or clothes, it has to be washed away thoroughly with soap.
- (2) After the module's end of life, it is not harmful in case of normal operation and storage.

9.5 SAFETY STANDARDS

The LCD module should be certified with safety regulations as follows:

- (1) UL60950-1 or updated standard.
- (2) IEC60950-1 or updated standard.

9.6 OTHER

When fixed patterns are displayed for a long time, remnant image is likely to occur.

Appendix. OUTLINE DRAWING

